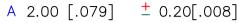
CPI0805JR47R-10

UNCONTROLLED DOCUMENT

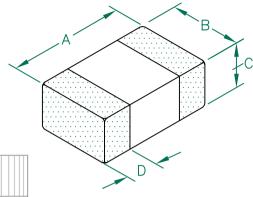
PHYSICAL DIMENSIONS:



B 1.25 [.049] ± 0.20[.008]

C 0.90 [.035] ± 0.10[.004]

D 0.50 [.020] ± 0.20[.008]



	ELECTRICAL CHARACTERISTICS:									
	L (μΗ) @ 1MHz ± 20%	DCR ($\frac{\Omega}{2}$) ± 25%	l (Max)							
Nom	0.47	0.10								
Min	0.38	0.075								
Max	0.56	0.125	1100mA							

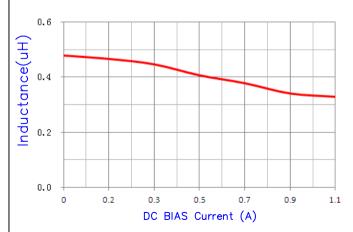
NOTES: UNLESS OTHERWISE SPECIFIED

- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 4000 PCS/REEL, PAPER TAPE.
- 2. TERMINATION FINISH IS 100% MATTE Sn OVER Ni.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. I (MAX.) IS BASED ON THE MAXIMUM SUSTAINED CURRENT APPLIED WHILE MAINTAINING A MAXIMUM TEMPERATURE RISE OF 40°C OVER AMBIENT.
- 5. OPERATION TEMPERATURE TEMP: -55°C~+125°C (INCLUDING SELF-HEATING)

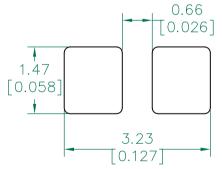
0.8 (Hn) 0.6 0.4 0.0 100 1.000

Ls vs Frequency

Frequency (MHz)
Ls vs DC BIAS Current

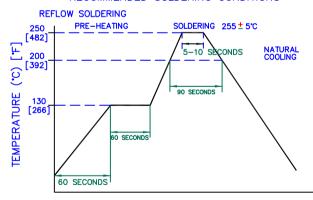


LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering. add 0.763 [0.030] to this dimension)

RECOMMENDED SOLDERING CONDITIONS





		DIMENSIONS ARE IN mm [INCHE	d nd	Laird					
					with the understanding that no copies shall be made without the written consent of Laird Tech. All rights to design or invention are reserved.		Lallu		
ł					PROJECT/PART NUMBER:	REV	PART TO	PE:	DRAWN BY:
t	С	CHANGE PLASTIC TAPE TO PAPER TAPE	04/17/14	QU	CPI0805JR47R-10	С	CO-FIRE		QU
[В	UPDATE LAIRD LOGO AND NOTES 5	08/05/13	QU	DATE: 03/01/11 SC	CALE: N	TC	SHEET:	
ſ	Α	ORIGINAL DRAFT	03/01/11	QU	1 ' ' 1	00L #	NTS		
Ī	REV	DESCRIPTION	DATE	INT	CPI0805JR47R-10-A	- · ·		1 of 1	